

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10045651			
<b>Filing Date:</b>	07-Nov-2001			
<b>Title of Invention:</b>	Multi-layer printed circuit board fabrication system and method			
<b>First Named Inventor:</b>	Amnon Ganot			
<b>Filer:</b>	Kelly G. Hyndman/Gina Schwartz			
<b>Attorney Docket Number:</b>	085/02455			
Filed as Large Entity				
<b>Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issurance:</b>				
<b>Extension-of-Time:</b>				
Extension for response within 2nd month	1252	1	450	450

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				450